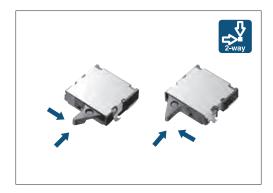
Compact Two-way Operation Type

A circuit variation of Normal Open and Normal Close







■ Typical Specifications

Ite	ms	Specifications		
Rating (max.)/(mi (Resistive load)	n.)	1mA 5V DC / 50μA 3V DC		
Contact resistand (Initial / After ope	-	2Ω max. / 5Ω max.		
Operating force		0.35N max.		
Operating life	Without load	50,000cycles		
Operating life	With load	50,000cycles (1mA 5V DC)		

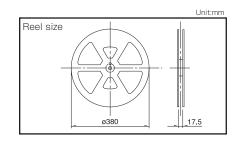
Product Line

Poles	Positions	Terminal type	Lever length	Operating direction	Circuit	Location lug	Flame leg	Minimum ord Japan	er unit (pcs.) Export	Product No.	Drawing No.																					
					N / O	With				SPVS310100	1																					
					N/O	Without	With	5,000		SPVS310200] '																					
					N/C	With			20,000	SPVS320100	2																					
		For PC board (Reflow)	Standard		N/C	Without				SPVS320200																						
1	1		Stariuaru		N/0	With				SPVS410100	- 3																					
'	'				Loft	Left	Loft	Loft	Loft	Loft	l oft	IN7 U	Without	VVILII	3,000	20,000	SPVS410200	3														
																									Leit		With				SPVS420100	4
																					N/C	Without				SPVS420200	4					
			Long Dight	Right		With				SPVS360100	5																					
			Long		HISHL			Without			SPVS360200																					

Packing Specifications

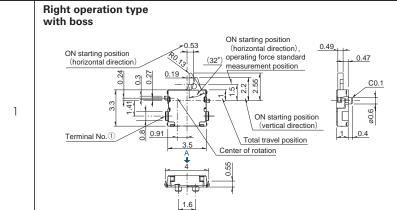
Taping

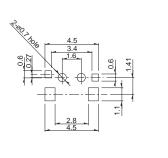
Nun	nber of packages (p	Tape width	Export package measurements		
1 reel	1 reel 1 case /Japan 1 case /export packing		(mm)	(mm)	
5,000	10,000	20,000	16	417×409×139	

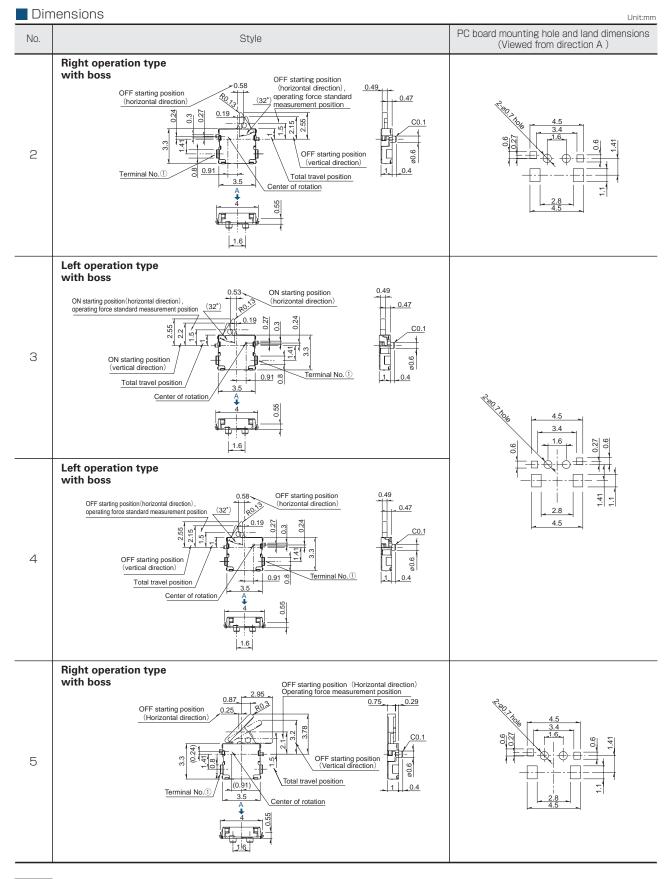


Dimensions

Dim	ensions	Unit:mm
No.	Style	PC board mounting hole and land dimensions (Viewed from direction A)
	Right operation type with boss	
	ON starting position	l







Note

Dimensions drawing is for type with location lugs.

Circuit Diagram

Control direction	Push ON (N/O)	Push OFF (N/C)
Right	Drawing No.1	Drawing No.2, 5
Left	Drawing No.3	Drawing No.4

■ Terminal Layout (Viewed from Direction A)

Control direction	Push ON (N/O) Push OFF (N/O)				
Right	Drawing No.1, 2, 5				
Left	Drawing No.3, 4				

List of Varieties

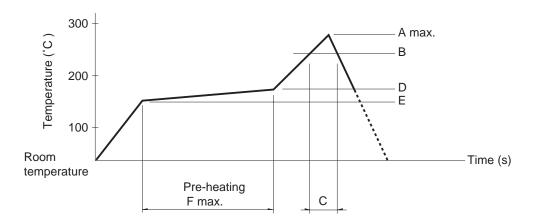
				General-pu	rpose Type	General-purpose Type						
(Series	SPVS	SPVN	SPVT	SPVM	SPVR	SPVE					
Photo						1						
Oper	ation type			Two-way			One-way					
	W	3.5	3.8	5.6	2.8	3.6	3.4					
Dimensio (mm)	ins D	3.3	3.6	4.7	3.5	4.2	3					
()	Н		1	1.9	1.5	1.2	2.3					
Operating to	emperature range			-40℃ to +85℃			-10℃ to +60℃					
Autor	notive use	•	•	•	•	•	_					
Life cycl	e (availability)	*3	*3	★3	*3	*3	* 3					
Poles	/ Positions			1.	/1							
Rating (max.) (Resistive load)		1mA 5V DC		50mA 20V DC	1mA 5V DC		0.1A 30V DC					
Rating (min.) (Resistive load)		50μA 3V DC		100μA 3V DC	50μA 3V DC	100μA 3V DC	50μA 3V DC					
	Operating life without load	50,000cycles 5Ω max.		100,000cycles 1Ω max.	$50,000$ cycles 5Ω max.		50,000cycles 1Ω max.					
Durability	Operating life with load Rating (max.) (Resistive load)	50,000cycles 5Ω max.		100,000cycles 1Ω max.	50,000cycles 5Ω max.		50,000cycles 1Ω max.					
	Initial contact resistance	2Ω max.		500mΩ max.	2Ω max.	3Ω max.	500mΩ max.					
Electrical performance	Insulation resistance			100MΩ min. 100V DC								
	Voltage proof			100V AC f	or 1 minute							
Mechanical	Terminal strength		0.5N for 1minute		1N for 1minute	0.5N foi	r Iminute					
performance	Actuator strength	Ę	5N	10N	5N	2N	5N					
	Cold		-40℃ 96h									
Environmental performance	Dry heat		1									
	Damp heat											
Opera	ation force	0.35	N max.	0.4N	0.4N max. 0.35N		0.3N max.					
	Page	16	19	21	24	26	27					

Note

Indicates applicability to all products in the series.

Example of Reflow Soldering Condition

- 1. Heating method: Double heating method with infrared heater.
 2. Temperature measurement: Thermocouple ϕ 0.1 to 0.2 CA (K) or CC (T) at soldering portion (copper foil surface).
 A heat resisting tape should be used for fixed measurement.
- 3. Temperature profile



Series (Reflow type)	A (℃) 3s max.	B (℃)	C (s)	D (°C)	E (℃)	F(s)
SPPB	250					
SPVE						
SPVL						
SPVM						
SPVN						
SPVR	260	230	40	180	150	120
SPVS						
SPVT						
SSCM						
SSCQ						
SPVQC	250					

Notes

- 1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, surface depending on the PC board's material, size, thickness, etc. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

■ Reference for Hand Soldering

Series	Soldering temperature	Soldering time
SPVS, SPVN, SPVT, SPVM, SPVR, SPVE, SSCQ, SSCM, SPVL, SSCT, SPVQC	350±5℃	3s max.
SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SSCN, SPVQA	300±10℃	3+1/0s
SPPB (Reflow)	300±5℃	5s max.
SSCF, SPPB (For Lead, Dip)	350±10℃	3+1/0s

■ Reference for Dip Soldering

(For PC board terminal types)

	Ite	ms	Dip soldering		
Series	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion	
SSCT, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SPVQA	100±10℃	60s max.	260±5℃	5±1s	
SPPW8, SPPB	100 ℃ max.	60s max.	255±5℃	5±1s	
SSCF	_		260±5℃	5±1s	